# **Bipolar Power Transistors**

## **PNP Silicon**

#### Features

- Epoxy Meets UL 94, V-0 @ 0.125 in
- ESD Ratings:
  - Human Body Model, 3B; > 8000 V
  - Machine Model, C; > 400 V
- NJV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

#### **MAXIMUM RATINGS** (T<sub>C</sub> = 25°C unless otherwise noted)

Rating	Symbol Value		Unit	
Collector-Emitter Voltage	V <sub>CEO</sub>	40	Vdc	
Collector-Base Voltage	V <sub>CB</sub>	40	Vdc	
Emitter-Base Voltage	V <sub>EB</sub>	6.0	Vdc	
Base Current – Continuous	Ι <sub>Β</sub>	1.0	Adc	
Collector Current Continuous Peak	۱ <sub>C</sub>	3.0 5.0	Adc	

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Мах	Unit
Total Power Dissipation Total P <sub>D</sub> @ T <sub>A</sub> = 25°C (Note 1) Total P <sub>D</sub> @ T <sub>A</sub> = 25°C (Note 2)	P <sub>D</sub>	2.0 0.80	W
Thermal Resistance, Junction-to-Case Junction-to-Ambient (Note 1) Junction-to-Ambient (Note 2)	${\sf R}_{ heta {\sf JA}} \ {\sf R}_{ heta {\sf JA}}$	64 155	°C/W
Maximum Lead Temperature for Soldering Purposes, 1/8" from case for 5 seconds	ΤL	260	°C
Operating and Storage Junction Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	– 55 to + 150	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. Mounted on 1" sq. (645 sq. mm) Collector pad on FR-4 bd material.

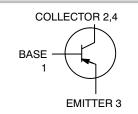
2. Mounted on 0.012" sq. (7.6 sq. mm) Collector pad on FR-4 bd material.

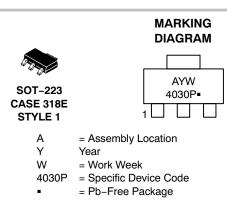


## **ON Semiconductor®**

http://onsemi.com

## PNP TRANSISTOR 3.0 AMPERES 40 VOLTS, 2.0 WATTS





#### ORDERING INFORMATION

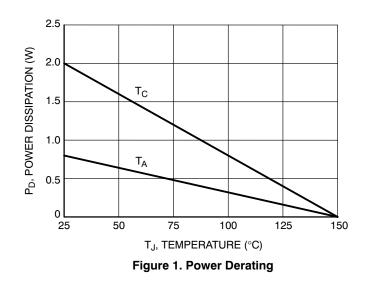
Device	Package	Shipping <sup>†</sup>
NJT4030NT1G	SOT-223	1000 / Tape &
NJV4030NT1G	(Pb-Free)	Reel
NJT4030NT3G	SOT-223	4000 / Tape &
NJV4030NT3G	(Pb-Free)	Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

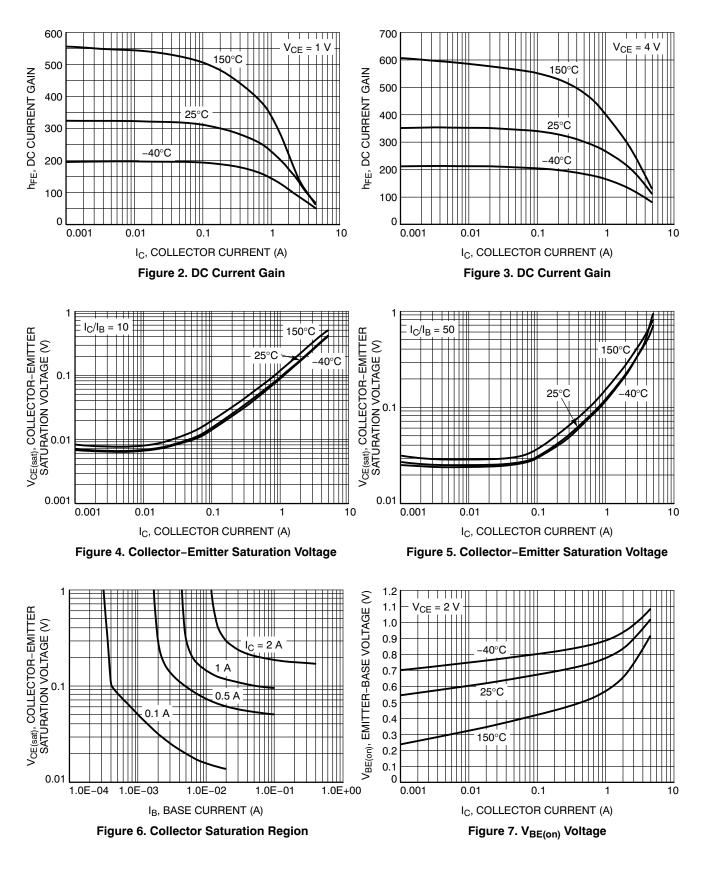
#### **ELECTRICAL CHARACTERISTICS** ( $T_C = 25^{\circ}C$ unless otherwise noted)

Characteristic	Symbol	Min	Тур	Мах	Unit
OFF CHARACTERISTICS			•	•	1
Collector–Emitter Sustaining Voltage $(I_C = 10 \text{ mAdc}, I_B = 0 \text{ Adc})$	V <sub>CEO(sus)</sub>	40	-	-	Vdc
Emitter–Base Voltage (I <sub>E</sub> = 50 μAdc, I <sub>C</sub> = 0 Adc)	V <sub>EBO</sub>	6.0	-	_	Vdc
Collector Cutoff Current (V <sub>CB</sub> = 40 Vdc)	I <sub>CBO</sub>	_	-	100	nAdc
Emitter Cutoff Current (V <sub>BE</sub> = 6.0 Vdc)	I <sub>EBO</sub>	_	_	100	nAdc
ON CHARACTERISTICS (Note 3)					
Collector-Emitter Saturation Voltage ( $I_C = 0.5 \text{ Adc}, I_B = 5.0 \text{ mAdc}$ ) ( $I_C = 1.0 \text{ Adc}, I_B = 10 \text{ mAdc}$ ) ( $I_C = 3.0 \text{ Adc}, I_B = 0.3 \text{ Adc}$ )	V <sub>CE(sat)</sub>	- - -	- - -	0.150 0.200 0.500	Vdc
Base-Emitter Saturation Voltage $(I_C = 1.0 \text{ Adc}, I_B = 0.1 \text{ Adc})$	V <sub>BE(sat)</sub>	_	_	1.0	Vdc
Base-Emitter On Voltage (I <sub>C</sub> = 1.0 Adc, V <sub>CE</sub> = 2.0 Vdc)	V <sub>BE(on)</sub>	_	_	1.0	Vdc
DC Current Gain ( $I_C = 0.5 \text{ Adc}, V_{CE} = 1.0 \text{ Vdc}$ ) ( $I_C = 1.0 \text{ Adc}, V_{CE} = 1.0 \text{ Vdc}$ ) ( $I_C = 3.0 \text{ Adc}, V_{CE} = 1.0 \text{ Vdc}$ )	h <sub>FE</sub>	220 200 100	- - -	- 400 -	-
DYNAMIC CHARACTERISTICS					
Output Capacitance (V <sub>CB</sub> = 10 Vdc, f = 1.0 MHz)	C <sub>ob</sub>	_	40	_	pF
Input Capacitance (V <sub>EB</sub> = 5.0 Vdc, f = 1.0 MHz)	C <sub>ib</sub>	_	130	_	pF
Current–Gain – Bandwidth Product (Note 4) ( $I_C = 500 \text{ mA}, V_{CE} = 10 \text{ V}, F_{test} = 1.0 \text{ MHz}$ )	fT	-	160	-	MHz

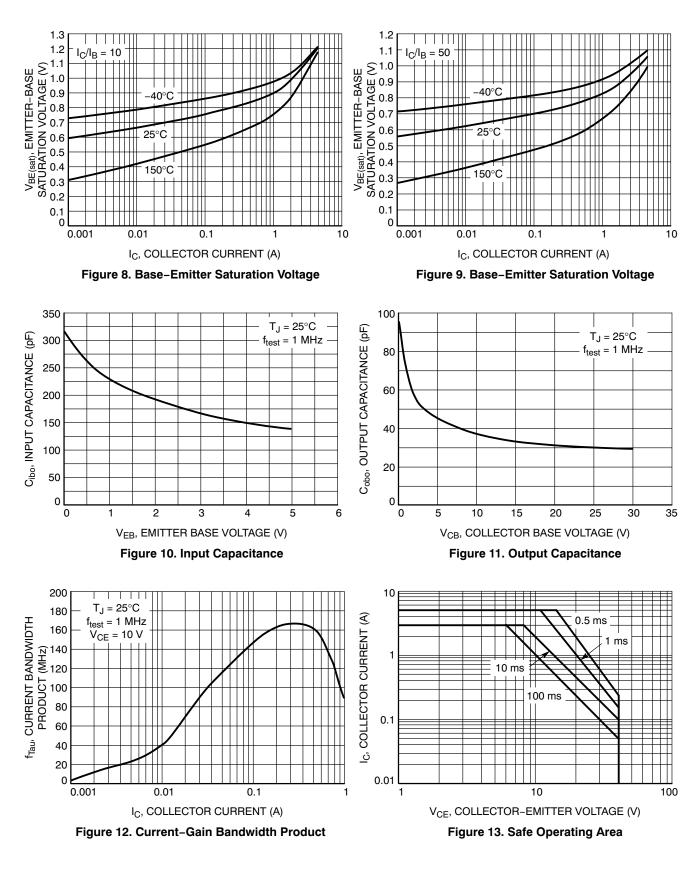
3. Pulse Test: Pulse Width  $\leq$  300 µs, Duty Cycle  $\leq$  2%. 4.  $f_T = |h_{FE}| \bullet f_{test}$ 



### **TYPICAL CHARACTERISTICS**

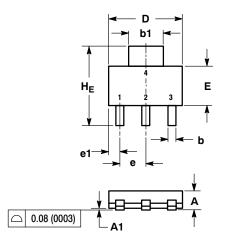


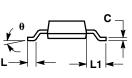
## **TYPICAL CHARACTERISTICS**



#### PACKAGE DIMENSIONS

SOT-223 (TO-261) CASE 318E-04 ISSUE N





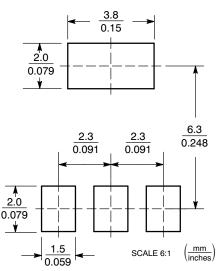
NOTES:

DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
CONTROLLING DIMENSION: INCH.

	MILLIMETERS			INCHES		
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α	1.50	1.63	1.75	0.060	0.064	0.068
A1	0.02	0.06	0.10	0.001	0.002	0.004
b	0.60	0.75	0.89	0.024	0.030	0.035
b1	2.90	3.06	3.20	0.115	0.121	0.126
С	0.24	0.29	0.35	0.009	0.012	0.014
D	6.30	6.50	6.70	0.249	0.256	0.263
Е	3.30	3.50	3.70	0.130	0.138	0.145
е	2.20	2.30	2.40	0.087	0.091	0.094
e1	0.85	0.94	1.05	0.033	0.037	0.041
L	0.20		-	0.008		-
L1	1.50	1.75	2.00	0.060	0.069	0.078
ΗE	6.70	7.00	7.30	0.264	0.276	0.287
θ	0°	-	10°	0°	-	10°

STYLE 1: PIN 1. BASE 2. COLLECTOR 3. EMITTER 4. COLLECTOR

#### **SOLDERING FOOTPRINT\***



\*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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